Document Number: 94501

Revision: 04-May-10

# GB100TS60NPbF

RoHS

COMPLIANT

Vishay High Power Products

## **INT-A-PAK** "Half-Bridge" (Ultrafast Speed IGBT), 108 A



- Generation 5 Non Punch Through (NPT) technology
- · Ultrafast: Optimized for hard switching speed 8 kHz to 60 kHz
- Low V<sub>CE(on)</sub>
- 10 µs short circuit capability
- Square RBSOA
- Positive V<sub>CE(on)</sub> temperature coefficient
- HEXFRED® antiparallel diode with ultrasoft reverse recovery characteristics
- Industry standard package
- Al<sub>2</sub>O<sub>3</sub> DBC
- UL approved file E78996
- Compliant to RoHS directive 2002/95/EC
- · Designed for industrial level

#### **BENEFITS**

- · Benchmark efficiency for UPS and welding application
- Rugged transient performance
- Direct mounting on heatsink
- · Very low junction to case thermal resistance

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS	
Collector to emitter voltage	V <sub>CES</sub>		600	V	
Continuous collector current		T <sub>C</sub> = 25 °C	108		
Continuous collector current	I <sub>C</sub>	T <sub>C</sub> = 80 °C	74		
Pulsed collector current	I <sub>CM</sub>		200	A	
Clamped inductive load current	I <sub>LM</sub>		200	A	
Diode continuous forward current		T <sub>C</sub> = 25 °C	106		
Didde continuous forward current	I <sub>F</sub>	T <sub>C</sub> = 80 °C	69		
Gate to emitter voltage	V <sub>GE</sub>		± 20	V	
Maximum power dissipation	Р	T <sub>C</sub> = 25 °C	390	W	
	PD	T <sub>C</sub> = 80 °C	219	vv	
Isolation voltage	V <sub>ISOL</sub>	Any terminal to case, t = 1 min	2500	V	

For technical questions, contact: indmodules@vishay.com







# **INT-A-PAK**

PRODUCT SUMMARY	
V <sub>CES</sub>	600 V
I <sub>C</sub> DC	108 A

600 V		
108 A		
2.6 V		
2.6 V		

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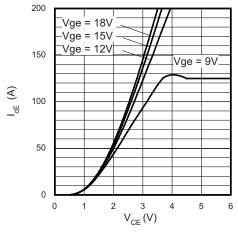
<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	V <sub>BR(CES)</sub>	$V_{GE}=0~V,~I_C=500~\mu A$	600	-	-	
	V <sub>CE(on)</sub>	$V_{GE} = 15 \text{ V}, I_{C} = 50 \text{ A}$	-	1.95	2.1	
		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 100 \text{ A}$	-	2.6	2.85	V
Collector to emitter voltage		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 50 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	2.21	2.44	
		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 100 \text{ A}, \text{ T}_{J} = 125 ^{\circ}\text{C}$	-	3.05	3.38	
Gate threshold voltage	V <sub>GE(th)</sub>	$V_{CE} = V_{GE}$ , $I_C = 500 \ \mu A$	3	4.6	6	
Collector to emitter leakage current	I <sub>CES</sub>	$V_{GE} = 0 V, V_{CE} = 600 V$	-	0.01	0.1	mA
		$V_{GE} = 0 \text{ V}, \text{ V}_{CE} = 600 \text{ V}, \text{ T}_{J} = 150 ^{\circ}\text{C}$	-	3.7	10	IIIA
Diode forward voltage drop	V <sub>FM</sub>	I <sub>C</sub> = 50 A	-	1.35	1.66	- V
		I <sub>C</sub> = 100 A	-	1.57	1.96	
		I <sub>C</sub> = 50 A, T <sub>J</sub> = 125 °C	-	1.27	1.50	
		I <sub>C</sub> = 100 A, T <sub>J</sub> = 125 °C	-	1.57	1.89	
Gate to emitter leakage current	I <sub>GES</sub>	$V_{GE} = \pm 20 \text{ V}$	-	-	± 200	nA

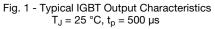
<b>SWITCHING CHARACTERISTICS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Turn-on switching loss	Eon		-	0.6	-	
Turn-off switching loss	E <sub>off</sub>	I <sub>C</sub> = 100 A, V <sub>CC</sub> = 360 V, V <sub>GE</sub> = 15 V, R <sub>a</sub> = 4.7 Ω, L = 200 μH, T <sub>J</sub> = 25 °C	-	1.1	-	
Total switching loss	E <sub>tot</sub>		-	1.7	-	
Turn-on switching loss	E <sub>on</sub>		-	0.8	-	mJ
Turn-off switching loss	E <sub>off</sub>		-	1.3	-	
Total switching loss	E <sub>tot</sub>		-	2.1	-	
Turn-on delay time	t <sub>d(on)</sub>	I <sub>C</sub> = 100 A, V <sub>CC</sub> = 360 V, V <sub>GE</sub> = 15 V, R <sub>a</sub> = 4.7 Ω, L = 200 μH, T <sub>J</sub> = 125 °C	-	197	-	
Rise time	t <sub>r</sub>	···g ···,oo p.·., · J ·o o	-	50	-	
Turn-off delay time	t <sub>d(off)</sub>		-	225	-	ns
Fall time	t <sub>f</sub>		-	72	-	
Reverse bias safe operating area	RBSOA	$T_J = 150 \text{ °C}, I_C = 200 \text{ A},$ $R_g = 27 \Omega, V_{GE} = 15 \text{ V to } 0$	Fullsquare			
Short circuit safe operating area	SCSOA	$\begin{split} T_{J} &= 150 ~^{\circ}\text{C}, ~ V_{CC} = 400 ~ \text{V}, ~ V_{P} = 600 ~ \text{V}, \\ R_{g} &= 27 ~ \Omega, ~ V_{GE} = 15 ~ \text{V} ~ \text{to} ~ 0 \end{split}$	10	-	-	
Diode reverse recovery time	t <sub>rr</sub>		-	116	140	ns
Diode peak reverse current	I <sub>rr</sub>	I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>CC</sub> = 400 V, T <sub>I</sub> = 25 °C	-	11	15	А
Diode recovery charge	Q <sub>rr</sub>		-	600	1050	nC
Diode reverse recovery time	t <sub>rr</sub>		-	152	190	ns
Diode peak reverse current	I <sub>rr</sub>	I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>CC</sub> = 400 V, T <sub>I</sub> = 125 °C	-	16	20	А
Diode recovery charge	Q <sub>rr</sub>		-	1215	1900	nC

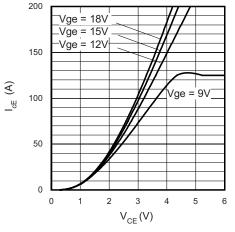


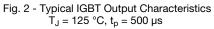
INT-A-PAK "Half-Bridge" Vishay High Power Products (Ultrafast Speed IGBT), 108 A

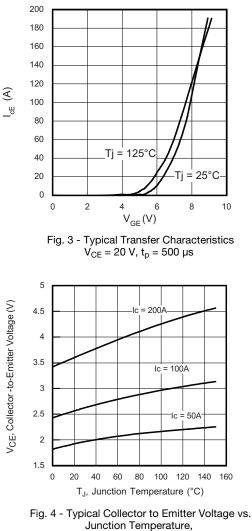
THERMAL AND MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	MIN.	TYP.	MAX.	UNITS
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>Stg</sub>	- 40	-	150	°C
Junction to case per leg	IGBT	R <sub>thJC</sub>	-	0.23	0.32	°C/W
	Diode		-	0.38	0.64	
Case to sink per module		R <sub>thCS</sub>	-	0.1	-	-
Mounting torque	case to heatsink		-	-	4	Nm
	case to terminal 1, 2, 3		-	-	3	
Weight			-	185	-	g











## Vishay High Power Products

S INT-A-PAK "Half-Bridge" (Ultrafast Speed IGBT), 108 A



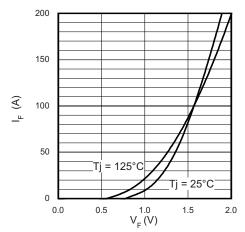
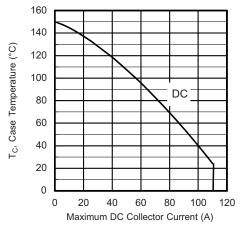
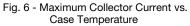
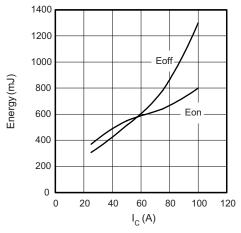
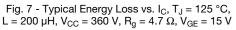


Fig. 5 - Diode Forward Characteristics,  $t_p = 500 \ \mu s$ 









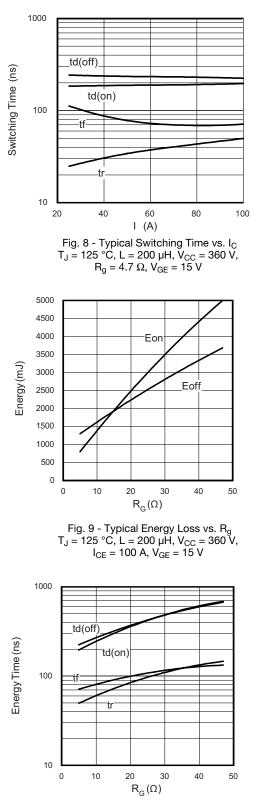
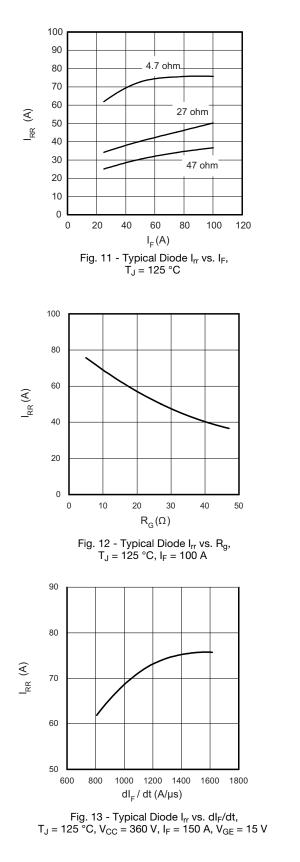


Fig. 10 - Typical Switching Time vs.  $R_g$   $T_J$  = 125 °C, L = 200  $\mu H,$   $V_{CC}$  = 360 V,  $I_{CE}$  = 100 A,  $V_{GE}$  = 15 V



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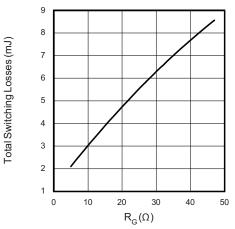


Fig. 14 - Typical Switching Losses vs. Gate Resistance,  $T_J$  = 125 °C, L = 200  $\mu H,~R_g$  = 10  $\Omega,~V_{CC}$  = 360 V,  $V_{GE}$  = 15 V

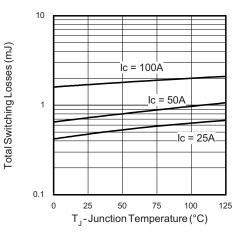


Fig. 15 - Typical Switching Losses vs. Junction Temperature, L = 200  $\mu H,\,R_g$  = 10  $\Omega,\,V_{CC}$  = 360 V,  $V_{GE}$  = 15 V

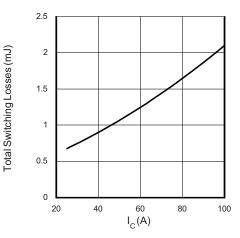


Fig. 16 - Typical Switching Losses vs. Collector to Emitter Current,  $T_J$  = 125 °C,  $R_{g1}$  = 4.7 V,  $R_{g2}$  = 0  $\Omega$ ,  $V_{CC}$  = 360 V,  $V_{GE}$  = 15 V

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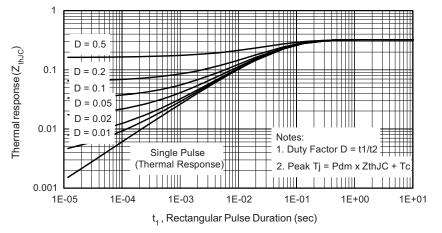


Fig. 17 - Maximum Transient Thermal Impedance, Junction to Case (IGBT)

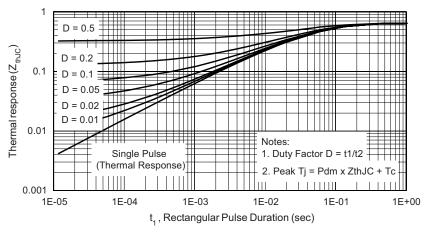
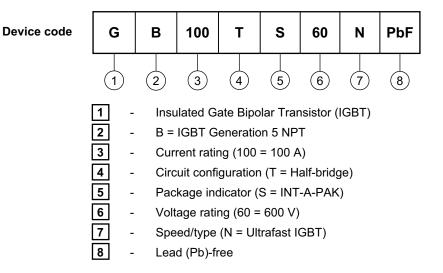


Fig. 18 - Maximum Transient Thermal Impedance, Junction to Case (HEXFRED®)

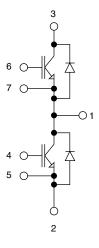


INT-A-PAK "Half-Bridge" Vishay High Power Products (Ultrafast Speed IGBT), 108 A

### ORDERING INFORMATION TABLE



### **CIRCUIT CONFIGURATION**



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95173			



Vishay

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